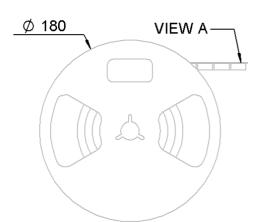
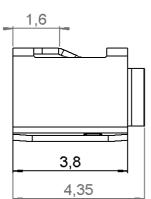
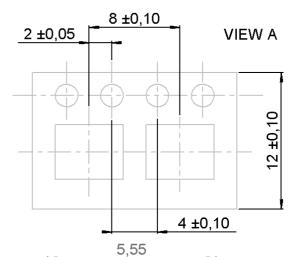
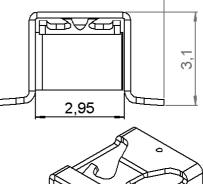
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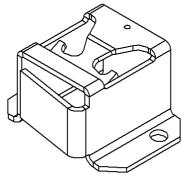
Series: UMP













All dimensions are in mm.

COMPONENTS	MATERIALS	PLATINGS (µm)

	1	
BODY	BERYLLIUM COPPER	G
CENTER CONTACT	-	-
OUTER CONTACT	-	-
INSULATOR	-	
GASKET	-	
OTHERS PARTS	-	-
-	-	-
-	-	-
	1	

GOLD 0.2 OVER NICKEL 2
-

**Issue:** 1213 C

In the effort to improve our products, we reserve the right to make changes judged to be necessary



**BOBINE 100** 

R107.303.040

Series: UMP

### **PACKAGING**

Standard	Unit	Other
100	'W' option	Contact us

## **SPECIFICATION**

### **ELECTRICAL CHARACTERISTICS**

Impedance  $\mathbf{50} \Omega$ 

Frequency **0-6** GHz VSWR **1.05** + **0,0300** x F(0)

VSWR 1.05 + 0,0300 x F(GHz) Maxi Insertion loss NA  $\sqrt{F(GHz)}$  dB Maxi RF leakage - ( NA - F(GHz)) dB Maxi

RF leakage - ( NA - F(GHz)) d Voltage rating 100 Veff Maxi Dielectric withstanding voltage 350 Veff mini Insulation resistance 1000 M $\Omega$  mini

## **ENVIRONMENTAL**

Operating temperature -40/+125 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

## **OTHERS CHARACTERISTICS**

Assembly instruction

Others:

## **MECHANICAL CHARACTERISTICS**

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

- N mini
- N.cm mini

Recommended torque

Mating - N.cm Panel nut - N.cm

Mating life 50 Cycles mini

Weight **0,0600** g

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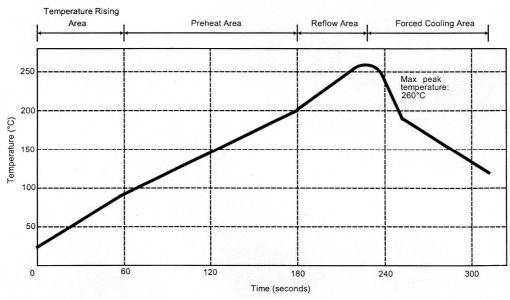
Series: UMP

## SOLDER PROCEDURE OF UMP RECEPTABLE IN INDUSTRIAL ENVIRONMENT

- 1. Deposit solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
  - We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. A video camera is recommended for positioning of the component . Adhesive agents must not be used on the receptacle.
- 3. This process of soldering has been tested with convection oven .Below please find ,the typical profile to use.
- 4. The cleaning of printed circuit boards is not obliged.
- 5. Verification of solder joints and position of the component by visual inspection.

NOTE: The UMP receptacle and the UMP plug must not be mated before completion of this procedure

### **TEMPERATURE PROFILE**



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec

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**BOBINE 100** 

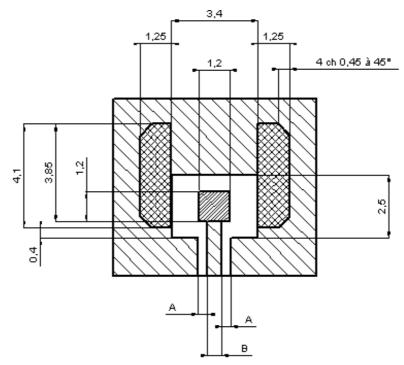
Series: UMP

## **UMP SERIES INFORMATION**

## **PCB**

#### **COPLANAR LINE**

Ground and signal are on the same side The material of PCB is glass is glass-epoxy Composite.



Sold over nickel for solder paste

Gold over nickel contact area free of any surface contaminant

Ground + varnish

## APPLICATION 75 $\Omega$ WITH B = 0,55mm

PCB thickness (mm)	Coplanar ligne A (mm)
0,8	0,57
1,0	0,45
1,2	0,41
1,6	0,37

APPILCATION  $50\Omega$  WITH B = 1,2mm

PCB thickness (mm)	Coplanar ligne A (mm)
0,8	0,183
1,0	0,190
1,2	0,195
1,6	0,20

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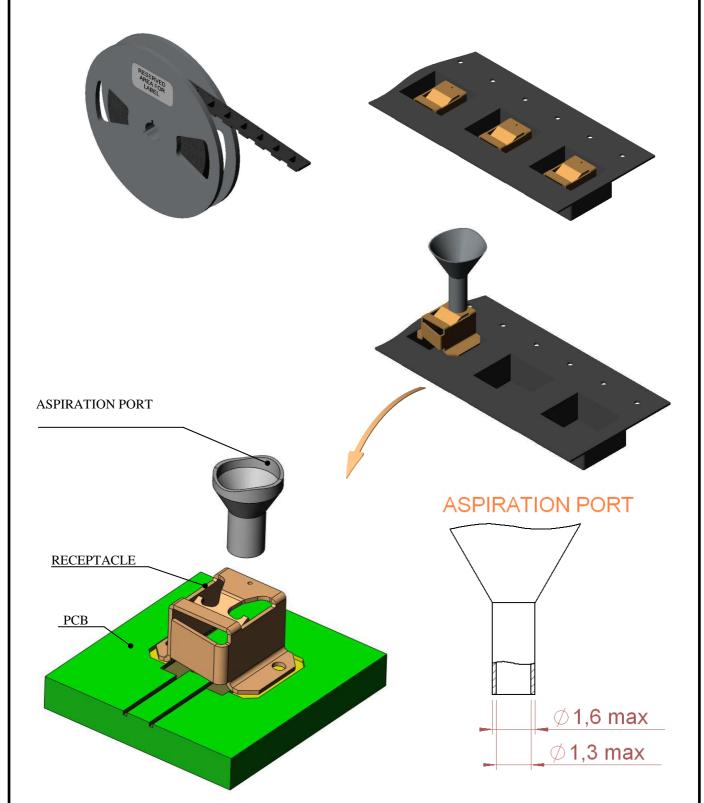


**BOBINE 100** 

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Series: UMP

## **UMP SERIES INFORMATION**



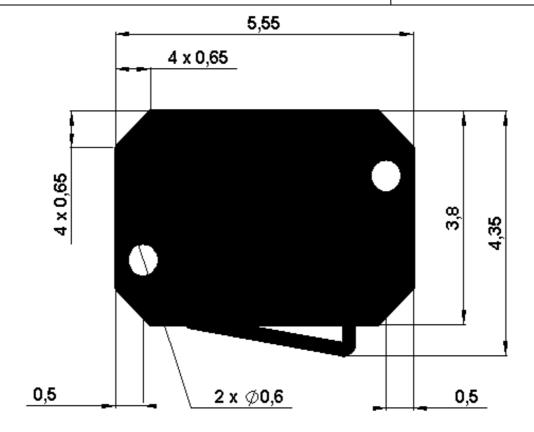
**Issue:** 1213 C
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**BOBINE 100** 

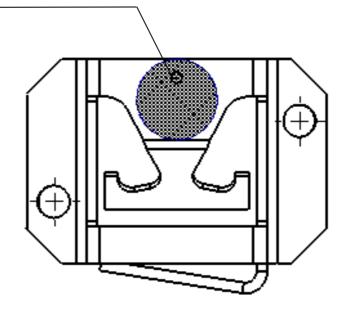
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## SHADOW FOR VIDEO CAMERA

## **ASPIRATION AREA**



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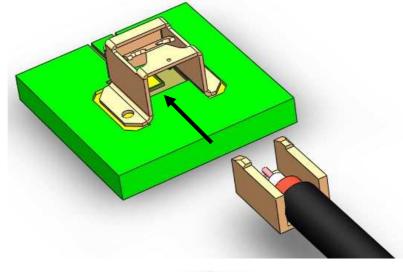


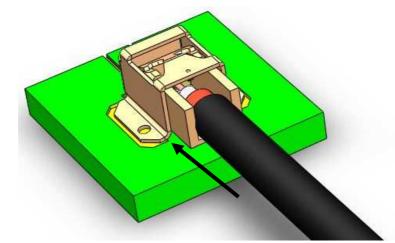
**BOBINE 100** 

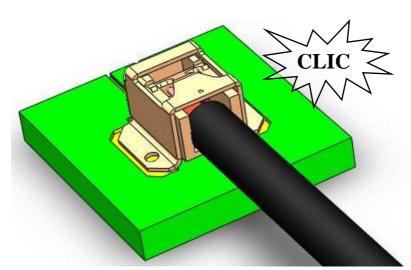
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Series: UMP

# **UMP CONNECTING NOTE**







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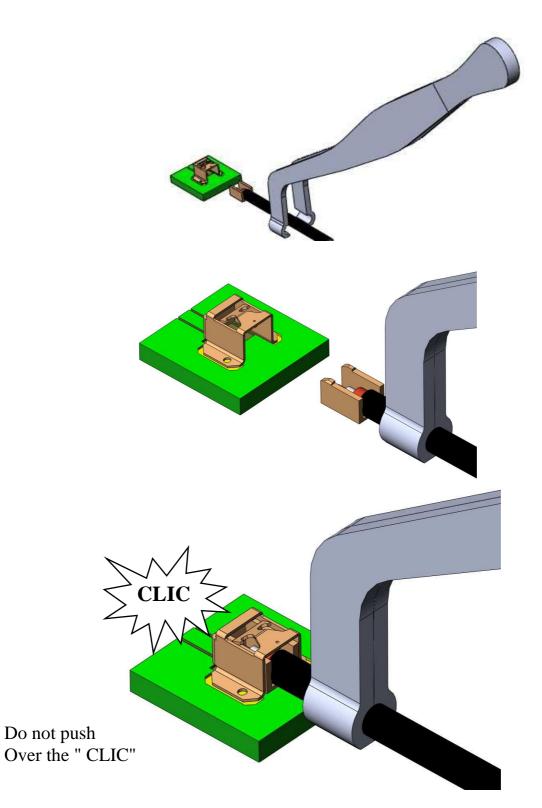


**BOBINE 100** 

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Series: UMP

## **UMP CONNECTING NOTE**



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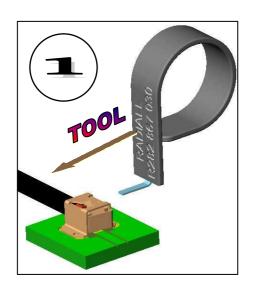


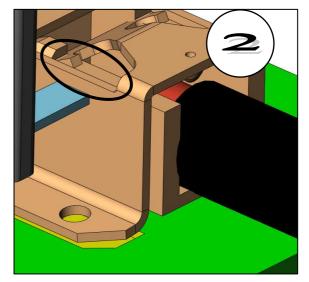
**BOBINE 100** 

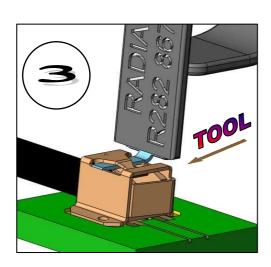
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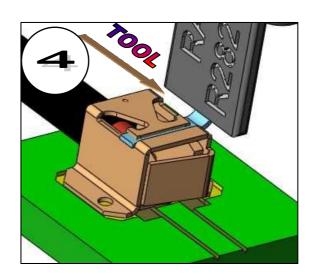
Series: UMP

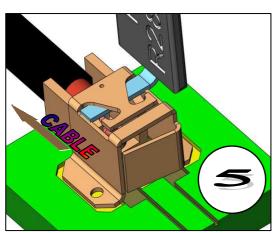
# **UMP DISCONNECTING NOTE**

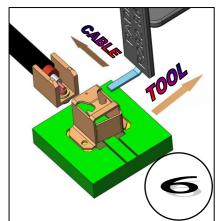












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